# PATENT APPLICATION

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

n re the Application of

Attn: OIPE

Shigehiro NISHINO et al.

Group Art Unit: 1722

Application No.:

10/520,141

Docket No.:

122261

Filed: September 1, 2005

For:

LARGE-DIAMETER SIC WAFER AND MANUFACTURING METHOD THEREOF

# REQUEST FOR CORRECTION OF PALM RECORDS

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Attached is a photocopy of the corrected filing receipt on which errors have been corrected in red. These errors are being brought to the attention of the Patent and Trademark Office so that it may correct its records.

Respectfully submitted,

Registration No. 27,075

Mario A. Costantino Registration No. 33,565

JAO:MAC/lah

Date: December 5, 2006

OLIFF & BERRIDGE, PLC P.O. Box 19928 Alexandria, Virginia 22320 Telephone: (703) 836-6400

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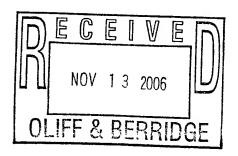


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UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. SOX 1450 Alexandria, Vitignia 22313-1450

APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/520,141	09/01/2005	1722	1030	122261	3	5	2

25944 OLIFF & BERRIDGE, PLC P.O. BOX 19928 ALEXANDRIA, VA 22320





Date Mailed: 11/08/2006

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

### Applicant(s)

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## **Assignment For Published Patent Application**

MITSUI ENGINEERING & SHIPBUILDING CO., LTB, TOKYO, JAPAN

LTD -)

Power of Attorney: The patent practitioners associated with Customer Number 25944.

#### Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP03/08312 06/30/2003

#### Foreign Applications

JAPAN 2002-202953 07/11/2002

If Required, Foreign Filing License Granted: 09/12/2006

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is US10/520,141

Projected Publication Date: Not Applicable

Non-Publication Request: No

## Early Publication Request: No

Title

Large-Diameter SiC Wafer and Manufacturing Method Thereof

# **Preliminary Class**

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